



60V P-Channel Enhancement Mode MOSFET

Voltage

-60 V

Current

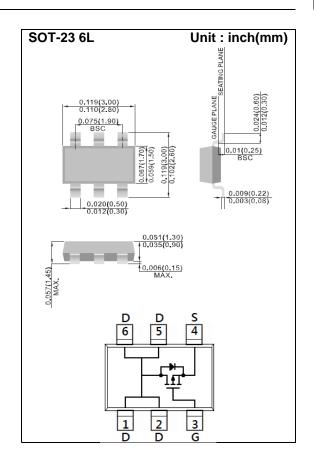
-3.2A

Features

- $R_{DS(ON)}$, $V_{GS}@-10V$, $I_D@-3.2A<110m\Omega$
- $R_{DS(ON)}$, $V_{GS}@-4.5V$, $I_D@-1.6A<130m\Omega$
- High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 Standard

Mechanical Data

- Case: SOT-23 6L Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0005 ounces, 0.014 grams



Maximum Ratings and Thermal Characteristics ($T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage		V_{DS}	-60		
Gate-Source Voltage		V _{GS} <u>+</u> 20		\ \ \ \	
Continuous Drain Current (Note 4)	T _A =25°C		-3.2		
	T _A =70°C	l _D	-2.5	А	
Pulsed Drain Current (Note 1)		I _{DM}	-20		
Power Dissipation	T _A =25°C		2	W	
	T _A =70°C	P _D	1.3		
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~150	°C	
Typical Thermal Resistance - Junction to Ambient (Note 4,5)		R _{θJA}	62.5	°C/W	





Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-60	-	-	\/
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=-250uA$	-1.0	-1.6	-2.5 V	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-3.2A	-	88	110	mΩ
		V _{GS} =-4.5V, I _D =-1.6A	-	110	130	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V, V _{GS} =0V	-	-	-1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V, V _{DS} =0V	-	-	<u>+</u> 100	nA
Dynamic (Note 6)						
Total Gate Charge	Q_{g}	V_{DS} =-30V, I_{D} =-3.2A, V_{GS} =-10V (Note 2,3)	-	10	-	nC
Gate-Source Charge	Q_gs		-	1.6	-	
Gate-Drain Charge	Q_{gd}		-	3	-	
Input Capacitance	Ciss	V _{DS} =-30V, V _{GS} =0V, f=1MHZ	-	785	-	pF
Output Capacitance	Coss		-	176	-	
Reverse Transfer Capacitance	Crss		-	116	-	
Turn-On Delay Time	td _(on)		-	8	-	
Turn-On Rise Time	tr	V_{DS} =-30V, I_{D} =-1A, V_{GS} =-10V, R_{G} =6.2 Ω (Note 2,3)	-	15	-	ns
Turn-Off Delay Time	td _(off)		-	43	-	
Turn-Off Fall Time	tf		-	8.4	-	
Drain-Source Diode						
Maximum Continuous Drain-Source					-2	А
Diode Forward Current	I _S		-	-	-∠	
Diode Forward Voltage	V_{SD}	I _S =-1A, V _{GS} =0V	-	-0.77	-1	V

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J =25°C.
- 4. The maximum current rating is package limited.
- 5. R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 6. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

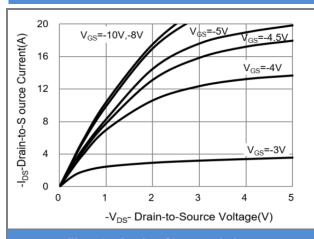


Fig.1 On-Region Characteristics

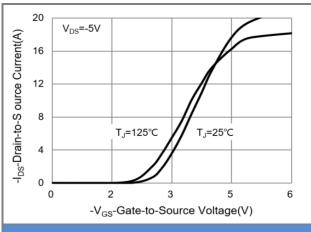


Fig.2 Transfer Characteristics

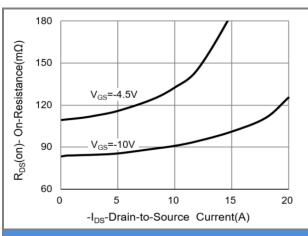


Fig.3 On-Resistance vs. Drain Current

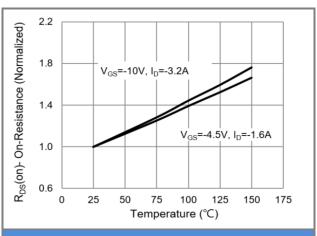


Fig.4 On-Resistance vs. Junction temperature

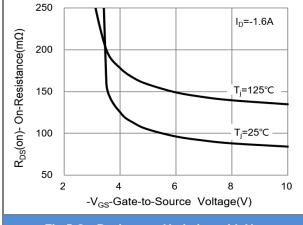


Fig.5 On-Resistance Variation with V_{GS}

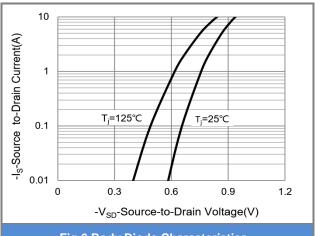


Fig.6 Body Diode Characteristics





TYPICAL CHARACTERISTIC CURVES

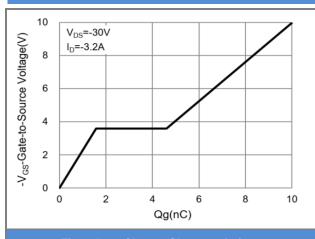


Fig.7 Gate-Charge Characteristics

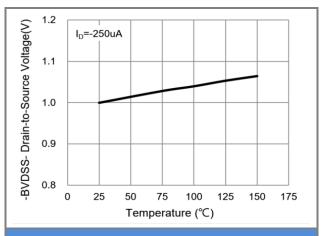


Fig.8 Breakdown Voltage Variation vs. Temperature

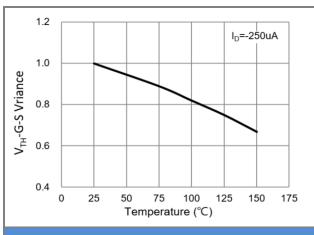


Fig.9 Threshold Voltage Variation with Temperature

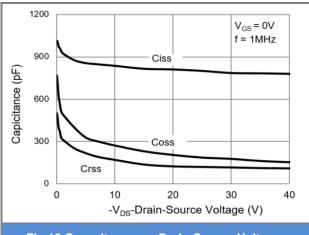


Fig.10 Capacitance vs. Drain-Source Voltage

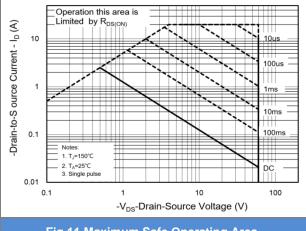


Fig.11 Maximum Safe Operating Area

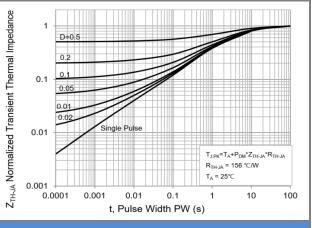


Fig.12 Normalized Transient Thermal Impedance

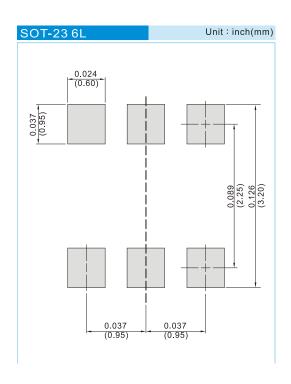




Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
PJS6461-AU_S1_000A1	SOT-23 6L	3K pcs / 7" reel	S61	Halogen free

Mounting Pad Layout







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